## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

FAX: 886-2-2369 7233

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## FLIP-CHIP PACKAGE SUBSTRATE

	specification of whic				
<u>X</u>	is attached hereto.				
	was filed on as Application Ser		and was amended on_		
app app fore on v	cification, including t I acknowledge the lication in accordanc I hereby claim fore lication(s) for paten	the claims, as amended to duty to disclose inforce with Title 37, Code or ign priority benefits unit or inventor's certificatent or inventor's certificatent.	ind understand the content d by any amendment referred rmation which is material to of Federal Regulations, § 1, der Title 35, United States Co ate listed below and have difficate having a filing date be	ed to above. the patent 56(a). Code, § 119 also identifi	ability of this of any foreigr ed below any
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
	92205531	Taiwan, R.O.C.	2003/4/9	Х	
ı	I hereby appoint the following attorney(s) arnsact all business in the Patent and Trademark  Belinda Lee (Reg. No. 46,863)  Jiawei Huang (Reg. No. 43,330)  Charles C.H. Wu (Reg. No. 39,081)  SEND CORRESPONDENCE TO:  JIANQ CHYUN Intellectual Property Office 7F1, No. 100, Roosevelt Rd., Sec. 2, Taipei 100, Taiwan, R.O.C.  TEL: 886-2-2369 2800		nark Office connected therev  3) Charles Liu  0)		
-			DIRECT TELEPHONE CALLS TO: (Name and telephone number)		
-				la Lee	

## COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:

Chi-Hsing Han Date: Apr. 28, 2003

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